TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOS III)

2SK4017

Chopper Regulator, DC/DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain-source ON-resistance : $R_{DS (ON)} = 0.07 \Omega (typ.)$

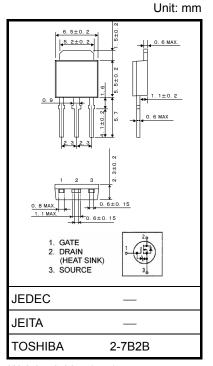
• High forward transfer admittance : $|Y_{fS}| = 6.0 \text{ S (typ.)}$

• Low leakage current : I_{DSS} = 100 μ A (max) (V_{DS} = 60 V)

• Enhancement mode : $V_{th} = 0.8 \sim 2.0 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Character	istic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	60	V
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	60	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	ID	5	Α
	Pulse (Note 1)	I _{DP}	20	Α
Drain power dissipatio	n (Tc = 25°C)	P _D	20	W
Single-pulse avalanch	e energy (Note 2)	E _{AS}	40.5	mJ
Avalanche current		I _{AR}	5	Α
Repetitive avalanche	energy (Note 3)	E _{AR}	2	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature r	ange	T _{stg}	-55~150	°C



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Мах	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 2.2 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



Electrical Characteristics (Ta = 25°C)

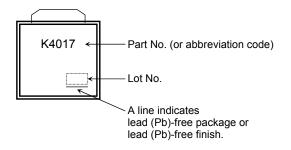
Charac	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μА
Drain cutoff curr	ent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μА
Drain-source br voltage	eakdown	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	60	_	_	٧
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.3	_	2.5	V
Drain-source ON-resistance		Pro (OV)	V _{GS} = 4 V, I _D = 2.5 A	_	0.09	0.15	Ω
		R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.5 A	_	0.07	0.10	
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	3.0	6.0	_	S
Input capacitano	e	C _{iss}			730	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		60	_	pF
Output capacitance		Coss			95	_	
Switching time	Rise time	t _r	V _{cs} _{OV}	_	10	_	
	Turn-on time	t _{on}		_	20	_	no
	Fall time	t _f		_	4	_	ns
	Turn-off time	t _{off}		_	35	_	
Total gate charge (gate-source plus gate-drain)		Qg	V _{DD} ≈ 48 V, V _{GS} = 10 V, I _D = 5 A		15		
Gate-source charge		Q _{gs}		_	11	_	nC
Gate-drain ("Miller") charge		Q _{gd}		_	4	_	

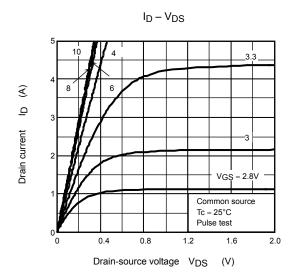
Source-Drain Ratings and Characteristics (Ta = 25°C)

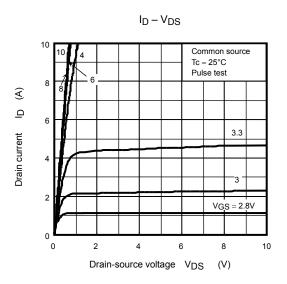
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	5	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	20	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I_{DR} = 5 A, V_{GS} = 0 V, dI_{DR} / dt = 50 A / μ s	_	34	_	ns
Reverse recovery charge	Q _{rr}		_	28	_	μС

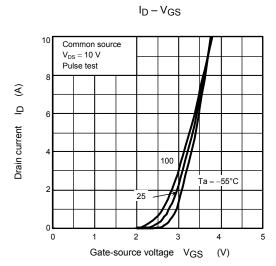
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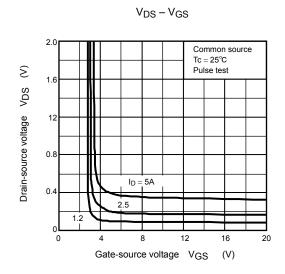
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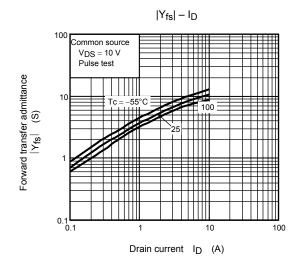


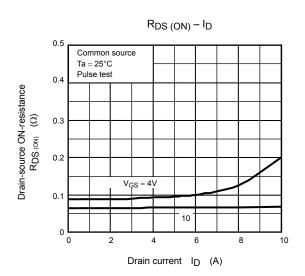


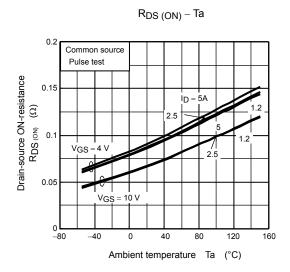


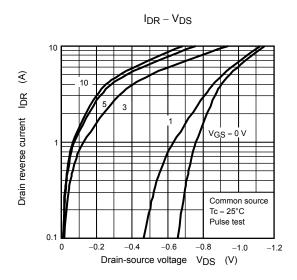


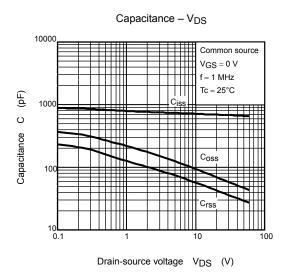


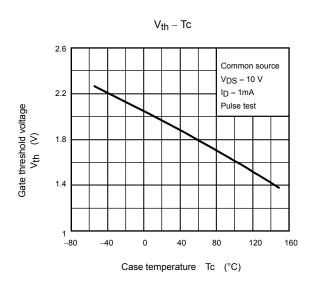


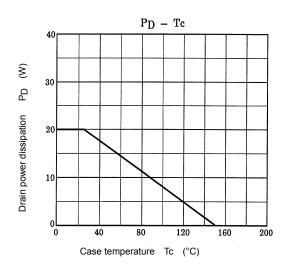


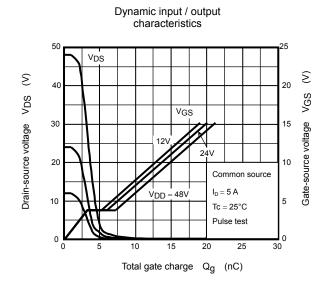


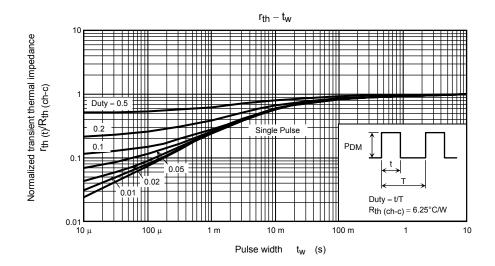


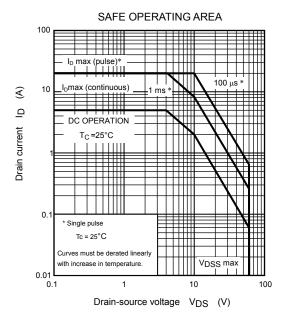


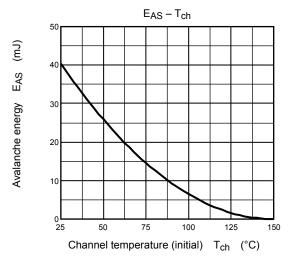


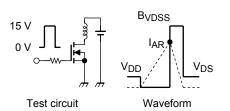












$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 25~V,~L = 2.2~mH \end{aligned} \qquad E_{AS} &= \frac{1}{2} \cdot L \cdot l^2 \cdot \left(\frac{BVDSS}{BVDSS} - V_{DD} \right) \end{aligned}$$

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